

10/24/02 THU 13:12 FAX 920 735 4488

MILLER ENGINEERING

DECLARATION AND POWER OF A FOR PATENT APPLICATION		ATTORNEY		7	ATTY. DOCKET NO. 2510.03	
As a below named inve	ntor. I hereb	v declare that:				
My residence/post office	e address an	d citizenshin are as se	ated below next to	m)/ name:		
i delleve I am the origin	nal, first and	sole inventor (if only	one name ie lieta	النجاحة حجام المعاملة	al, first and joint inventor (
are listed below) of the	subject matt	er which is claimed at	nd for which a pate	ent is sought on the in	vention entitled:	
	LOU	VER CONFIGUI	RATION FOR	WELDING API	PARATUS	
the specification of which	ch is attached	l hereto unless the fol	lowing box is che	rked:		
() was filed o	n	as US Applie	cation Serial No. o	PCT International	Analication	
i antithe?	ang was ar		ed on	.1\		
neredy state that I have	e reviewed a	nd understood the co	ntents of the above	a identified case:	tion, including the claims, material to patentability a	
oreign Application(s) and/o hereby claim foreign priority ave also identified below any	benefits under	Title 35 United Cores C	ode Section 119 of an (s) certificate having a	y foreign application(s) fo filing date before that of the	or patent or inventor(s) certificate he application on which prioriry i	
COUNTRY	APPL	CATION NUMBER	DATE FILE	D PRIO	RITY CLAIMED UNDER 35 U.S	
					· YES: NO:	
					YES:NO:	
Tovisional Application	a Tina DE VILL	10 0.4				
nereby claim the benefit undo	1 1116 33. Call	ed States Code Section 115	(c) of any United Stat	es provisional application(s) listed below:	
		APPLICATION SE	RIAL NUMBER	FILING DATE		
					_	
S. Priority Claim ereby claim the benefit under ims of this application is not mowledge the duty to disclos or application and the nation	se material info	emerion se defined in Title	ation in the manner p	application(s) listed below rovided by the first paragra Regulations, Section 1 56	w and, insofur as the subject man uph of Title 35, United States Co. (a) which occurred between the i	
APPLICATION SERIAL NUMBER		FILING DATE		STATUS	STATUS(patented/pending/abandoned)	
		+				
WER OF ATTORNEY:						
a named inventor. I hereby demark Office connected the	appoint the foi rewith.	lowing attorney(s) and/or	agent(s) listed below	to prosecute this applicat	tion and trunspet all business in	
Timothy J J. Mark V	I. Ziolkowski, 1 Vilkinson, Reg.	Reg. No. 38,368 No. 48,865			•	
ng with the following registe	red attorneys	and agents of Illinois Too	ol Works Inc., 3600 V	est Lake Avenue, Gleavi	iew, IL 60025-5811:	
	Croll, Reg. No.			·	,	
Donald J.	Breh, Reg. No.	. 30,159				
Lixa M. So	Itis, Reg. No. 4	10, 623		•		
John H. Pi Paul F. Do	tarski, Reg. No novan, Reg. N	o. 33,028				
R. Wayne :	Pritchard, Reg	. No. 34.903				
Benjamin 3	J. Hauptman, I	Reg. No. 29, 310				

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Mequon, W1 53097-1416	
hereby declare that all statements made herein of my own knowledge are true and	I that all statements made on information and helief are believed as he re-
that these statements were made with the knowledge that willful false statements an	I the like so made are nunishable by fine or imprisonment as but and
hat these statements were made with the knowledge that willful false statements an of Title 18 of the United States Code and that such willful false statements may jeop Full Name of Inventor: James J. Cigelske, Jr.	I the like so made are nunishable by fine or imprisonment as but and
Full Name of Inventor: James J. Cizelske, Jr.	d the like so made are punishable by fine or imprisonment, or both, unde paidize the validity of the application or any patent issued thereon
that these statements were made with the knowledge that willful false statements and of Title 18 of the United States Code and that such willful false statements may jeop	d the like so made are punishable by fine or imprisonment, or both, unde paidize the validity of the application or any patent issued thereon